PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHAOLI LIU	09/10/2019
XINKAI SONG	09/20/2019
BINGRUI WANG	09/20/2019
YAO ZHANG	09/24/2019
SHUAI HU	09/20/2019

RECEIVING PARTY DATA

Name:	CAMBRICON TECHNOLOGIES CORPORATION LIMITED
Street Address:	NO. 7 ZHICHUN ROAD, HAIDIAN DISTRICT
Internal Address:	FLOOR 11, BLOCK D, ZHIZHEN BUILDING
City:	BEIJING
State/Country:	CHINA
Postal Code:	100191

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17688853

CORRESPONDENCE DATA

Fax Number: (703)821-8128

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 703-995-9887 uspto@bayes.law Email: **BAYES PLLC Correspondent Name:**

8260 GREENSBORO DRIVE Address Line 1:

Address Line 2: **SUITE 625**

Address Line 4: MCLEAN, UNITED STATES 22102

ATTORNEY DOCKET NUMBER:	10015-01-0010-US-CON5CON1
NAME OF SUBMITTER:	JIAYU SONG
SIGNATURE:	/Jiayu Song/
DATE SIGNED:	03/07/2022
	This document serves as an Oath/Declaration (37 CFR 1.63).

PATENT

REEL: 059190 FRAME: 0183 507164569

Total Attachments: 15 source=10015-01-0010-US-CON5_Declaration_Assignment#page1.tif source=10015-01-0010-US-CON5 Declaration Assignment#page2.tif source=10015-01-0010-US-CON5 Declaration Assignment#page3.tif source=10015-01-0010-US-CON5_Declaration_Assignment#page4.tif source=10015-01-0010-US-CON5 Declaration Assignment#page5.tif source=10015-01-0010-US-CON5 Declaration Assignment#page6.tif source=10015-01-0010-US-CON5_Declaration_Assignment#page7.tif source=10015-01-0010-US-CON5_Declaration_Assignment#page8.tif source=10015-01-0010-US-CON5 Declaration Assignment#page9.tif source=10015-01-0010-US-CON5 Declaration Assignment#page10.tif source=10015-01-0010-US-CON5_Declaration_Assignment#page11.tif source=10015-01-0010-US-CON5 Declaration Assignment#page12.tif source=10015-01-0010-US-CON5 Declaration Assignment#page13.tif source=10015-01-0010-US-CON5_Declaration_Assignment#page14.tif source=10015-01-0010-US-CON5_Declaration_Assignment#page15.tif

DECLARATION

As the below named inventor, I hereby declare that:

both.

	This d	eclaration is directed to:
	\boxtimes	The attached application, or
		United States application or PCT international application number
		filed on
	The ab	ove-identified application was made or authorized to be made by me.
inventi		eve that I am the original inventor or an original joint inventor of a claimed application.
	I here	by acknowledge that any willful false statement made in this declaration is

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) or equivalent and other good and valuable consideration paid to the below named inventor, the below named inventor, hereby sells and assigns to Cambricon Technologies Corporation Limited, a corporation formed under the laws of China, whose mailing address is Floor 11, Block D, Zhizhen Building, No 7 of Zhichun Road, Haidian District, Beijing 100191, P.R. China (hereafter referred to as the Assignee), his/her entire right, title and interest, including the right to sue for past infringement and to collect for all past, present and future damages, for the United States of America (as defined in 35 U.S.C. § 100) and throughout the world,

punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or

- (a) in the invention(s) known as INTEGRATED CIRCUIT CHIP APPARATUS for which application(s) for patent in the United States of America is identified above, in any and all applications thereon, in any and all Letters Patent(s) therefor, and
- (b) in any and all applications that claim the benefit of the patent application identified above in part (a), including non-provisional applications, continuing (continuation, divisional, or continuation-in-part) applications, reissues, extensions, renewals and reexaminations of the patent application or Letters Patent therefor listed above in part (a), to the full extent of the term or terms for which Letters Patents issue, and

all such rights, title and interest to be held and enjoyed by the above-named Assignee, its successors, legal representatives and assigns to the same extent as all such rights, title and interest would have been held and enjoyed by the Assignor had this assignment and sale not been made.

The below named inventor agrees to execute all papers necessary in connection with the application(s) and any non-provisional, continuing (continuation, divisional, or continuation-in-part), reissue, reexamination or corresponding application(s) thereof and also to execute separate assignments in connection with such application(s) as the Assignee may deem necessary or expedient.

The below named inventor agrees to execute all papers necessary in connection with any patent enforcement action (judicial or otherwise) related to the application(s) or any non-provisional, continuing (continuation, divisional, or continuation-in-part), reissue or reexamination application(s) thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such patent enforcement action.

The below named inventor hereby represents that he/she has full right to convey the entire interest herein assigned, and that he/she has not executed, and will not execute, any agreement in conflict therewith.

IN his/her nar		IEREOF, executed	by the below	named	inventor on	the date	opposite
LEGAL N	AME OF INVE	ENTOR					
Inventor:	Shaoli LIU	ShallLh	Date:	9,10	2/19		
Signature	of Inventor:						

DECLARATION

As the	below named inventor, I hereby declare that:
This d	eclaration is directed to:
\boxtimes	The attached application, or
	United States application or PCT international application number
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The al	pove-identified application was made or authorized to be made by me.
	eve that I am the original inventor or an original joint inventor of a claimed he application.
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IN his/her nan	WITNESS WHE	REOF,	executed	by the	below	named	inventor	on the	date	opposite
LEGAL N	AME OF INVEN	TOR								
Inventor:	Xinkai, SONG			Date:		20.9.	2019		~~~	
Signature o	of Inventor:	Xinkai	Song							

DECLARATION

As the below named inventor, I hereby declare that:

both.

	·
Thi	s declaration is directed to:
\boxtimes	The attached application, or
	United States application or PCT international application number
	filed on
The	above-identified application was made or authorized to be made by me.
	elieve that I am the original inventor or an original joint inventor of a claimed in the application.
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IN WITNESS WHEREOF, executed his/her name.	d by the bel	ow named inventor on the da	ate opposite
LEGAL NAME OF INVENTOR			
Inventor: Bingrui, WANG	Date:	9.20.2019	
Signature of Inventor: Bingrui	Wang		······.

DECLARATION

As the below named inventor, I hereby declare that:

	•	
This	declaration is directed to:	
\boxtimes	The attached application, or	
	United States application or PCT international application number	
	filed on	

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

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IN WITNESS WHER his/her name.	EOF, execu	ited by the belo	ow named inventor	on the date opposite
LEGAL NAME OF INVENT	O.R.			
Inventor: Yao, ZHANG		Date:	Sept. Leth	2019
Signature of Inventor:	Jus	Zhang		,

DECLARATION

As the below named inventor, I hereby declare that:

	This d	eclaration is directed to:				
	\boxtimes	The attached application, or				
	United States application or PCT international application number					
		filed on				
The above-identified application was made or authorized to be made by me.						
I believe that I am the original inventor or an original joint inventor of a claim						

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

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IN WITNESS WHEREOF, execut his/her name.	ted by the below	named inventor	on the date opposite
LEGAL NAME OF INVENTOR			
Inventor: Shuai, HU	Date:	Sept. 20.	2019
Signature of Inventor:	H		***************************************